

Welcome to [E-XFL.COM](#)

### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

|                            |                                                                                                                                                                     |
|----------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status             | Obsolete                                                                                                                                                            |
| Core Processor             | ARM7®                                                                                                                                                               |
| Core Size                  | 16/32-Bit                                                                                                                                                           |
| Speed                      | 70MHz                                                                                                                                                               |
| Connectivity               | I <sup>2</sup> C, Microwire, SPI, SSI, SSP, UART/USART                                                                                                              |
| Peripherals                | POR, PWM, WDT                                                                                                                                                       |
| Number of I/O              | 32                                                                                                                                                                  |
| Program Memory Size        | 32KB (32K x 8)                                                                                                                                                      |
| Program Memory Type        | FLASH                                                                                                                                                               |
| EEPROM Size                | -                                                                                                                                                                   |
| RAM Size                   | 8K x 8                                                                                                                                                              |
| Voltage - Supply (Vcc/Vdd) | 1.65V ~ 3.6V                                                                                                                                                        |
| Data Converters            | A/D 8x10b                                                                                                                                                           |
| Oscillator Type            | Internal                                                                                                                                                            |
| Operating Temperature      | -40°C ~ 85°C (TA)                                                                                                                                                   |
| Mounting Type              | Surface Mount                                                                                                                                                       |
| Package / Case             | 48-VFQFN Exposed Pad                                                                                                                                                |
| Supplier Device Package    | 48-HVQFN (6x6)                                                                                                                                                      |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc2103fhn48h-6-51">https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc2103fhn48h-6-51</a> |

5. Pinning information

5.1 Pinning

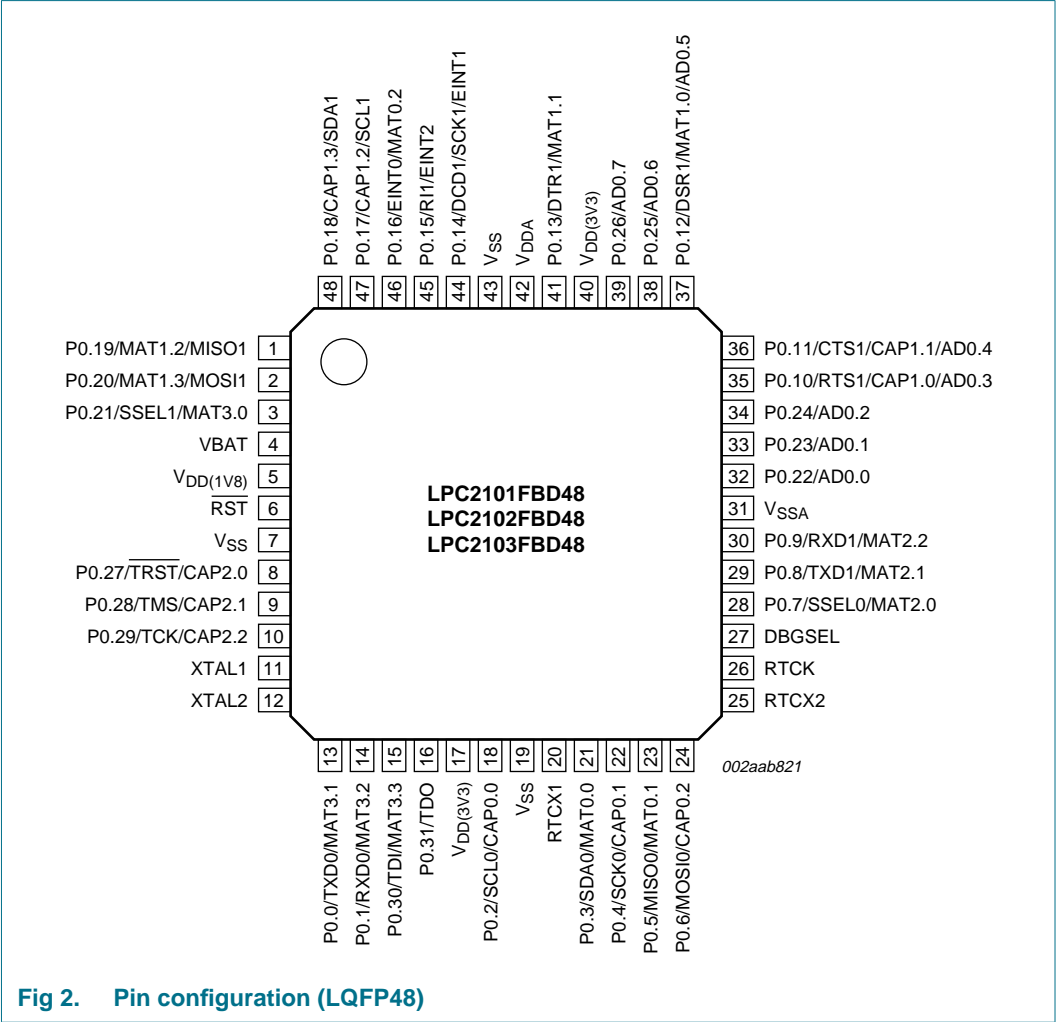


Fig 2. Pin configuration (LQFP48)

## 5.2 Pin description

**Table 3.** Pin description

| Symbol                      | Pin               | Type | Description                                                                                                                                                                                                                                                                                                              |
|-----------------------------|-------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| P0.0 to P0.31               |                   | I/O  | <b>Port 0:</b> Port 0 is a 32-bit I/O port with individual direction controls for each bit. A total of 31 pins of the Port 0 can be used as general purpose bidirectional digital I/Os while P0.31 is an output only pin. The operation of port 0 pins depends upon the pin function selected via the pin connect block. |
| P0.0/TXD0/<br>MAT3.1        | 13 <sup>[1]</sup> | I/O  | <b>P0.0</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | O    | <b>TXD0</b> — Transmitter output for UART0.                                                                                                                                                                                                                                                                              |
|                             |                   | O    | <b>MAT3.1</b> — PWM output 1 for Timer 3.                                                                                                                                                                                                                                                                                |
| P0.1/RXD0/<br>MAT3.2        | 14 <sup>[1]</sup> | I/O  | <b>P0.1</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | I    | <b>RXD0</b> — Receiver input for UART0.                                                                                                                                                                                                                                                                                  |
|                             |                   | O    | <b>MAT3.2</b> — PWM output 2 for Timer 3.                                                                                                                                                                                                                                                                                |
| P0.2/SCL0/<br>CAP0.0        | 18 <sup>[2]</sup> | I/O  | <b>P0.2</b> — General purpose input/output digital pin. Output is open-drain.                                                                                                                                                                                                                                            |
|                             |                   | I/O  | <b>SCL0</b> — I <sup>2</sup> C0 clock Input/output. Open-drain output (for I <sup>2</sup> C-bus compliance).                                                                                                                                                                                                             |
|                             |                   | I    | <b>CAP0.0</b> — Capture input for Timer 0, channel 0.                                                                                                                                                                                                                                                                    |
| P0.3/SDA0/<br>MAT0.0        | 21 <sup>[2]</sup> | I/O  | <b>P0.3</b> — General purpose input/output digital pin. Output is open-drain.                                                                                                                                                                                                                                            |
|                             |                   | I/O  | <b>SDA0</b> — I <sup>2</sup> C0 data input/output. Open-drain output (for I <sup>2</sup> C-bus compliance).                                                                                                                                                                                                              |
|                             |                   | O    | <b>MAT0.0</b> — PWM output for Timer 0, channel 0. Output is open-drain.                                                                                                                                                                                                                                                 |
| P0.4/SCK0/<br>CAP0.1        | 22 <sup>[1]</sup> | I/O  | <b>P0.4</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | I/O  | <b>SCK0</b> — Serial clock for SPI0. SPI clock output from master or input to slave.                                                                                                                                                                                                                                     |
|                             |                   | I    | <b>CAP0.1</b> — Capture input for Timer 0, channel 1.                                                                                                                                                                                                                                                                    |
| P0.5/MISO0/<br>MAT0.1       | 23 <sup>[1]</sup> | I/O  | <b>P0.5</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | I/O  | <b>MISO0</b> — Master In Slave Out for SPI0. Data input to SPI master or data output from SPI slave.                                                                                                                                                                                                                     |
|                             |                   | O    | <b>MAT0.1</b> — PWM output for Timer 0, channel 1.                                                                                                                                                                                                                                                                       |
| P0.6/MOSI0/<br>CAP0.2       | 24 <sup>[1]</sup> | I/O  | <b>P0.6</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | I/O  | <b>MOSI0</b> — Master Out Slave In for SPI0. Data output from SPI master or data input to SPI slave.                                                                                                                                                                                                                     |
|                             |                   | I    | <b>CAP0.2</b> — Capture input for Timer 0, channel 2.                                                                                                                                                                                                                                                                    |
| P0.7/SSEL0/<br>MAT2.0       | 28 <sup>[1]</sup> | I/O  | <b>P0.7</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | I    | <b>SSEL0</b> — Slave Select for SPI0. Selects the SPI interface as a slave.                                                                                                                                                                                                                                              |
|                             |                   | O    | <b>MAT2.0</b> — PWM output for Timer 2, channel 0.                                                                                                                                                                                                                                                                       |
| P0.8/TXD1/<br>MAT2.1        | 29 <sup>[1]</sup> | I/O  | <b>P0.8</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | O    | <b>TXD1</b> — Transmitter output for UART1.                                                                                                                                                                                                                                                                              |
|                             |                   | O    | <b>MAT2.1</b> — PWM output for Timer 2, channel 1.                                                                                                                                                                                                                                                                       |
| P0.9/RXD1/<br>MAT2.2        | 30 <sup>[1]</sup> | I/O  | <b>P0.9</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                  |
|                             |                   | I    | <b>RXD1</b> — Receiver input for UART1.                                                                                                                                                                                                                                                                                  |
|                             |                   | O    | <b>MAT2.2</b> — PWM output for Timer 2, channel 2.                                                                                                                                                                                                                                                                       |
| P0.10/RTS1/<br>CAP1.0/AD0.3 | 35 <sup>[3]</sup> | I/O  | <b>P0.10</b> — General purpose input/output digital pin.                                                                                                                                                                                                                                                                 |
|                             |                   | O    | <b>RTS1</b> — Request to Send output for UART1.                                                                                                                                                                                                                                                                          |
|                             |                   | I    | <b>CAP1.0</b> — Capture input for Timer 1, channel 0.                                                                                                                                                                                                                                                                    |
|                             |                   | I    | <b>AD0.3</b> — ADC 0, input 3.                                                                                                                                                                                                                                                                                           |

Table 3. Pin description ...continued

| Symbol                      | Pin                  | Type | Description                                                                                                                                              |
|-----------------------------|----------------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| P0.11/CTS1/<br>CAP1.1/AD0.4 | 36 <sup>[3]</sup>    | I/O  | <b>P0.11</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | I    | <b>CTS1</b> — Clear to Send input for UART1.                                                                                                             |
|                             |                      | I    | <b>CAP1.1</b> — Capture input for Timer 1, channel 1.                                                                                                    |
|                             |                      | I    | <b>AD0.4</b> — ADC 0, input 4.                                                                                                                           |
| P0.12/DSR1/<br>MAT1.0/AD0.5 | 37 <sup>[3]</sup>    | I/O  | <b>P0.12</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | I    | <b>DSR1</b> — Data Set Ready input for UART1.                                                                                                            |
|                             |                      | O    | <b>MAT1.0</b> — PWM output for Timer 1, channel 0.                                                                                                       |
|                             |                      | I    | <b>AD0.5</b> — ADC 0, input 5.                                                                                                                           |
| P0.13/DTR1/<br>MAT1.1       | 41 <sup>[1]</sup>    | I/O  | <b>P0.13</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | O    | <b>DTR1</b> — Data Terminal Ready output for UART1.                                                                                                      |
|                             |                      | O    | <b>MAT1.1</b> — PWM output for Timer 1, channel 1.                                                                                                       |
| P0.14/DCD1/<br>SCK1/EINT1   | 44 <sup>[4][5]</sup> | I/O  | <b>P0.14</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | I    | <b>DCD1</b> — Data Carrier Detect input for UART1.                                                                                                       |
|                             |                      | I/O  | <b>SCK1</b> — Serial Clock for SPI1. SPI clock output from master or input to slave.                                                                     |
|                             |                      | I    | <b>EINT1</b> — External interrupt 1 input.                                                                                                               |
| P0.15/RI1/<br>EINT2         | 45 <sup>[4]</sup>    | I/O  | <b>P0.15</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | I    | <b>RI1</b> — Ring Indicator input for UART1.                                                                                                             |
|                             |                      | I    | <b>EINT2</b> — External interrupt 2 input.                                                                                                               |
| P0.16/EINT0/<br>MAT0.2      | 46 <sup>[4]</sup>    | I/O  | <b>P0.16</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | I    | <b>EINT0</b> — External interrupt 0 input.                                                                                                               |
|                             |                      | O    | <b>MAT0.2</b> — PWM output for Timer 0, channel 2.                                                                                                       |
| P0.17/CAP1.2/<br>SCL1       | 47 <sup>[6]</sup>    | I/O  | <b>P0.17</b> — General purpose input/output digital pin. The output is not open-drain.                                                                   |
|                             |                      | I    | <b>CAP1.2</b> — Capture input for Timer 1, channel 2.                                                                                                    |
|                             |                      | I/O  | <b>SCL1</b> — I <sup>2</sup> C1 clock Input/output. This pin is an open-drain output if I <sup>2</sup> C1 function is selected in the pin connect block. |
| P0.18/CAP1.3/<br>SDA1       | 48 <sup>[6]</sup>    | I/O  | <b>P0.18</b> — General purpose input/output digital pin. The output is not open-drain.                                                                   |
|                             |                      | I    | <b>CAP1.3</b> — Capture input for Timer 1, channel 3.                                                                                                    |
|                             |                      | I/O  | <b>SDA1</b> — I <sup>2</sup> C1 data Input/output. This pin is an open-drain output if I <sup>2</sup> C1 function is selected in the pin connect block.  |
| P0.19/MAT1.2/<br>MISO1      | 1 <sup>[1]</sup>     | I/O  | <b>P0.19</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | O    | <b>MAT1.2</b> — PWM output for Timer 1, channel 2.                                                                                                       |
|                             |                      | I/O  | <b>MISO1</b> — Master In Slave Out for SSP. Data input to SSP master or data output from SSP slave.                                                      |
| P0.20/MAT1.3/<br>MOSI1      | 2 <sup>[1]</sup>     | I/O  | <b>P0.20</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | O    | <b>MAT1.3</b> — PWM output for Timer 1, channel 3.                                                                                                       |
|                             |                      | I/O  | <b>MOSI1</b> — Master Out Slave for SSP. Data output from SSP master or data input to SSP slave.                                                         |
| P0.21/SSEL1/<br>MAT3.0      | 3 <sup>[1]</sup>     | I/O  | <b>P0.21</b> — General purpose input/output digital pin.                                                                                                 |
|                             |                      | I    | <b>SSEL1</b> — Slave Select for SPI1. Selects the SPI interface as a slave.                                                                              |
|                             |                      | O    | <b>MAT3.0</b> — PWM output for Timer 3, channel 0.                                                                                                       |

Table 3. Pin description ...continued

| Symbol               | Pin       | Type | Description                                                                                                                                                                                                                        |
|----------------------|-----------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| V <sub>SS</sub>      | 7, 19, 43 | I    | <b>Ground:</b> 0 V reference.                                                                                                                                                                                                      |
| V <sub>SSA</sub>     | 31        | I    | <b>Analog ground:</b> 0 V reference. This should be nominally the same voltage as V <sub>SS</sub> but should be isolated to minimize noise and error.                                                                              |
| V <sub>DDA</sub>     | 42        | I    | <b>Analog 3.3 V power supply:</b> This should be nominally the same voltage as V <sub>DD(3V3)</sub> but should be isolated to minimize noise and error. The level on this pin also provides a voltage reference level for the ADC. |
| V <sub>DD(1V8)</sub> | 5         | I    | <b>1.8 V core power supply:</b> This is the power supply voltage for internal circuitry and the on-chip PLL.                                                                                                                       |
| V <sub>DD(3V3)</sub> | 17, 40    | I    | <b>3.3 V pad power supply:</b> This is the power supply voltage for the I/O ports.                                                                                                                                                 |
| VBAT                 | 4         | I    | <b>RTC power supply:</b> 3.3 V on this pin supplies the power to the RTC.                                                                                                                                                          |

- [1] 5 V tolerant (if V<sub>DD(3V3)</sub> and V<sub>DDA</sub> ≥ 3.0 V) pad providing digital I/O functions with TTL levels and hysteresis and 10 ns slew rate control.
- [2] Open-drain 5 V tolerant (if V<sub>DD(3V3)</sub> and V<sub>DDA</sub> ≥ 3.0 V) digital I/O I<sup>2</sup>C-bus 400 kHz specification compatible pad. It requires external pull-up to provide an output functionality. Open-drain configuration applies to ALL functions on that pin.
- [3] 5 V tolerant (if V<sub>DD(3V3)</sub> and V<sub>DDA</sub> ≥ 3.0 V) pad providing digital I/O (with TTL levels and hysteresis and 10 ns slew rate control) and analog input function. If configured for an input function, this pad utilizes built-in glitch filter that blocks pulses shorter than 3 ns. When configured as an ADC input, digital section of the pad is disabled.
- [4] 5 V tolerant (if V<sub>DD(3V3)</sub> and V<sub>DDA</sub> ≥ 3.0 V) pad providing digital I/O functions with TTL levels and hysteresis and 10 ns slew rate control. If configured for an input function, this pad utilizes built-in glitch filter that blocks pulses shorter than 3 ns.
- [5] A LOW level during reset on pin P0.14 is considered as an external hardware request to start the ISP command handler.
- [6] Open-drain 5 V tolerant (if V<sub>DD(3V3)</sub> and V<sub>DDA</sub> ≥ 3.0 V) digital I/O I<sup>2</sup>C-bus 400 kHz specification compatible pad. It requires external pull-up to provide an output functionality. Open-drain configuration applies only to I<sup>2</sup>C function on that pin.
- [7] Pad provides special analog functionality.
- [8] For lowest power consumption, pin should be left floating when the RTC is not used.
- [9] See *LPC2101/02/03 User manual UM10161* for details.

## 6. Functional description

### 6.1 Architectural overview

The ARM7TDMI-S is a general purpose 32-bit microprocessor, which offers high performance and very low power consumption. The ARM architecture is based on Reduced Instruction Set Computer (RISC) principles, and the instruction set and related decode mechanism are much simpler than those of microprogrammed Complex Instruction Set Computers (CISC). This simplicity results in a high instruction throughput and impressive real-time interrupt response from a small and cost-effective processor core.

Pipeline techniques are employed so that all parts of the processing and memory systems can operate continuously. Typically, while one instruction is being executed, its successor is being decoded, and a third instruction is being fetched from memory.

The ARM7TDMI-S processor also employs a unique architectural strategy known as Thumb, which makes it ideally suited to high-volume applications with memory restrictions, or applications where code density is an issue.

The key idea behind Thumb is that of a super-reduced instruction set. Essentially, the ARM7TDMI-S processor has two instruction sets:

- The standard 32-bit ARM set.
- A 16-bit Thumb set.

The Thumb set's 16-bit instruction length allows it to approach twice the density of standard ARM code while retaining most of the ARM's performance advantage over a traditional 16-bit processor using 16-bit registers. This is possible because Thumb code operates on the same 32-bit register set as ARM code.

Thumb code is able to provide up to 65 % of the code size of ARM, and 160 % of the performance of an equivalent ARM processor connected to a 16-bit memory system.

The particular flash implementation in the LPC2101/02/03 allows for full speed execution also in ARM mode. It is recommended to program performance critical and short code sections in ARM mode. The impact on the overall code size will be minimal but the speed can be increased by 30 % over Thumb mode.

### 6.2 On-chip flash program memory

The LPC2101/02/03 incorporate a 8 kB, 16 kB or 32 kB flash memory system respectively. This memory may be used for both code and data storage. Programming of the flash memory may be accomplished in several ways. It may be programmed in system via the serial port. The application program may also erase and/or program the flash while the application is running, allowing a great degree of flexibility for data storage field firmware upgrades, etc. The entire flash memory is available for user code as the bootloader resides in a separate memory.

The LPC2101/02/03 flash memory provides a minimum of 100,000 erase/write cycles and 20 years of data-retention memory.

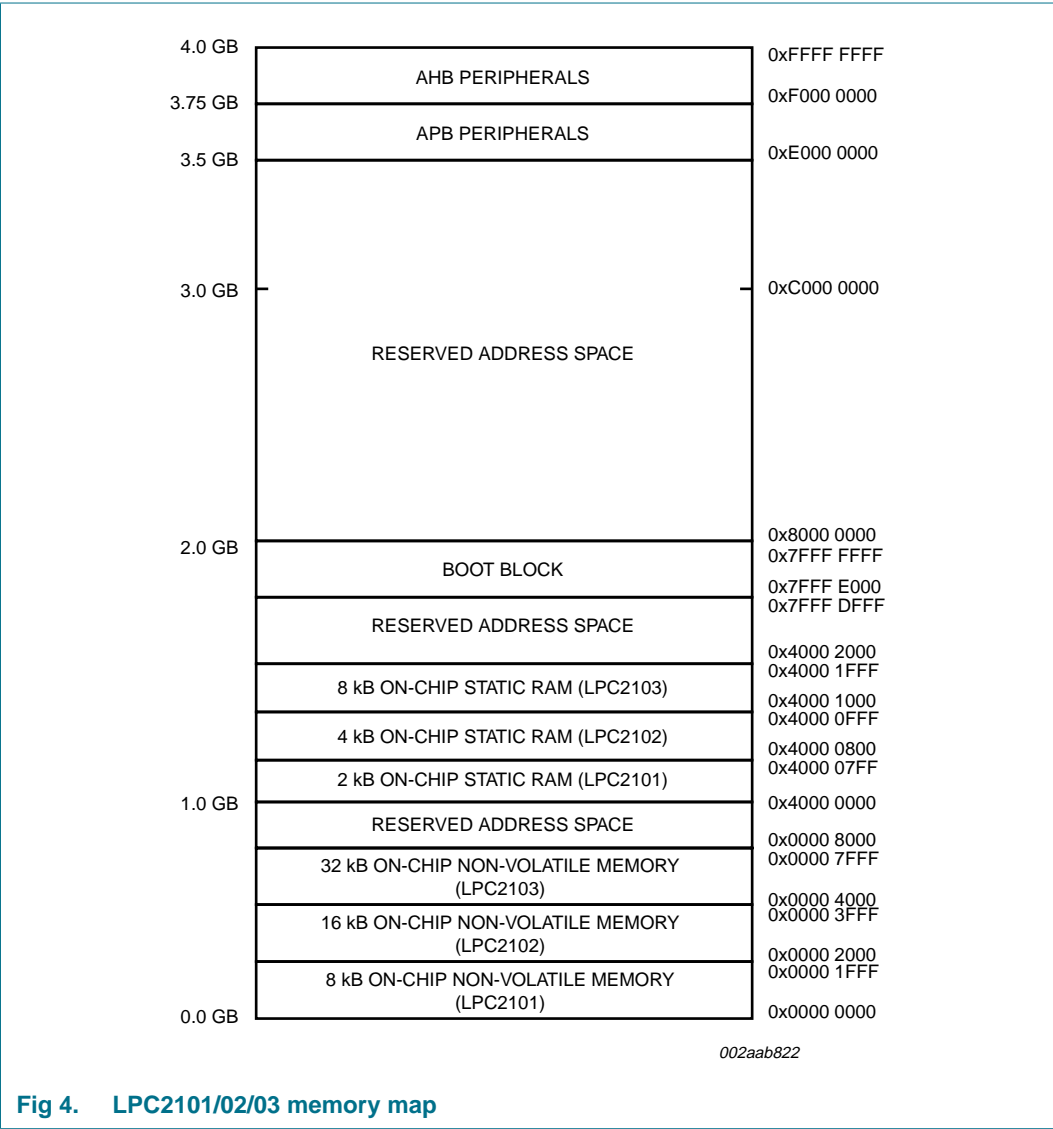
6.3 On-chip static RAM

On-chip static RAM may be used for code and/or data storage. The SRAM may be accessed as 8-bits, 16-bits, and 32-bits. The LPC2101/02/03 provide 2 kB, 4 kB or 8 kB of static RAM.

6.4 Memory map

The LPC2101/02/03 memory map incorporates several distinct regions, as shown in [Figure 4](#).

In addition, the CPU interrupt vectors may be re-mapped to allow them to reside in either flash memory (the default) or on-chip static RAM. This is described in [Section 6.17](#) “System control”.



## 6.5 Interrupt controller

The VIC accepts all of the interrupt request inputs and categorizes them as FIQ, vectored IRQ, and non-vectored IRQ as defined by programmable settings. The programmable assignment scheme means that priorities of interrupts from the various peripherals can be dynamically assigned and adjusted.

FIQ has the highest priority. If more than one request is assigned to FIQ, the VIC combines the requests to produce the FIQ signal to the ARM processor. The fastest possible FIQ latency is achieved when only one request is classified as FIQ, because then the FIQ service routine does not need to branch into the interrupt service routine but can run from the interrupt vector location. If more than one request is assigned to the FIQ class, the FIQ service routine will read a word from the VIC that identifies which FIQ source(s) is (are) requesting an interrupt.

Vectored IRQs have the middle priority. Sixteen of the interrupt requests can be assigned to this category. Any of the interrupt requests can be assigned to any of the 16 vectored IRQ slots, among which slot 0 has the highest priority and slot 15 has the lowest.

Non-vectored IRQs have the lowest priority.

The VIC combines the requests from all the vectored and non-vectored IRQs to produce the IRQ signal to the ARM processor. The IRQ service routine can start by reading a register from the VIC and jumping there. If any of the vectored IRQs are pending, the VIC provides the address of the highest-priority requesting IRQs service routine, otherwise it provides the address of a default routine that is shared by all the non-vectored IRQs. The default routine can read another VIC register to see what IRQs are active.

### 6.5.1 Interrupt sources

Each peripheral device has one interrupt line connected to the Vectored Interrupt Controller, but may have several internal interrupt flags. Individual interrupt flags may also represent more than one interrupt source.

## 6.6 Pin connect block

The pin connect block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on chip peripherals. Peripherals should be connected to the appropriate pins prior to being activated, and prior to any related interrupt(s) being enabled. Activity of any enabled peripheral function that is not mapped to a related pin should be considered undefined.

The pin control module with its pin select registers defines the functionality of the microcontroller in a given hardware environment.

After reset all pins of Port 0 are configured as input with the following exceptions: If the DBGSEL pin is HIGH (Debug mode enabled), the JTAG pins will assume their JTAG functionality for use with EmbeddedICE and cannot be configured via the pin connect block.



## 6.7 Fast general purpose parallel I/O

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The value of the output register may be read back, as well as the current state of the port pins.

LPC2101/02/03 introduce accelerated GPIO functions over prior LPC2000 devices:

- GPIO registers are relocated to the ARM local bus for the fastest possible I/O timing.
- Mask registers allow treating sets of port bits as a group, leaving other bits unchanged.
- All GPIO registers are byte addressable.
- Entire port value can be written in one instruction.

### 6.7.1 Features

- Bit-level set and clear registers allow a single instruction set or clear of any number of bits in one port.
- Direction control of individual bits.
- Separate control of output set and clear.
- All I/O default to inputs after reset.

## 6.8 10-bit ADC

The LPC2101/02/03 contain one ADC. It is a single 10-bit successive approximation ADC with eight channels.

### 6.8.1 Features

- Measurement range of 0 V to 3.3 V.
- Each converter capable of performing more than 400,000 10-bit samples per second.
- Burst conversion mode for single or multiple inputs.
- Optional conversion on transition on input pin or Timer Match signal.
- Every analog input has a dedicated result register to reduce interrupt overhead.

## 6.9 UARTs

The LPC2101/02/03 each contain two UARTs. In addition to standard transmit and receive data lines, UART1 also provides a full modem control handshake interface.

Compared to previous LPC2000 microcontrollers, UARTs in LPC2101/02/03 include a fractional baud rate generator for both UARTs. Standard baud rates such as 115200 can be achieved with any crystal frequency above 2 MHz.

### 6.9.1 Features

- 16 byte Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1, 4, 8, and 14 bytes

- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Transmission FIFO control enables implementation of software (XON/XOFF) flow control on both UARTs.
- UART1 is equipped with standard modem interface signals. This module also provides full support for hardware flow control (auto-CTS/RTS).

## 6.10 I<sup>2</sup>C-bus serial I/O controllers

The LPC2101/02/03 each contain two I<sup>2</sup>C-bus controllers.

The I<sup>2</sup>C-bus is bidirectional, for inter-IC control using only two wires: a Serial Clock Line (SCL), and a Serial Data Line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (e.g., LCD driver) or a transmitter with the capability to both receive and send information such as serial memory. Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I<sup>2</sup>C-bus is a multi-master bus, it can be controlled by more than one bus master connected to it.

The I<sup>2</sup>C-bus implemented in LPC2101/02/03 supports bit rates up to 400 kbit/s (Fast I<sup>2</sup>C-bus).

### 6.10.1 Features

- Compliant with standard I<sup>2</sup>C-bus interface.
- Easy to configure as Master, Slave, or Master/Slave.
- Programmable clocks allow versatile rate control.
- Bidirectional data transfer between masters and slaves.
- Multi-master bus (no central master).
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus.
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
- The I<sup>2</sup>C-bus can also be used for test and diagnostic purposes.

## 6.11 SPI serial I/O controller

The LPC2101/02/03 each contain one SPI controller. The SPI is a full duplex serial interface, designed to handle multiple masters and slaves connected to a given bus. Only a single master and a single slave can communicate on the interface during a given data transfer. During a data transfer the master always sends 8 bits to 16 bits of data to the slave, and the slave always sends 8 bits to 16 bits of data to the master.

### 6.11.1 Features

- Compliant with SPI specification.
- Synchronous, Serial, Full Duplex, Communication.

- Incorrect/Incomplete feed sequence causes reset/interrupt if enabled.
- Flag to indicate watchdog reset.
- Programmable 32-bit timer with internal pre-scaler.
- Selectable time period from  $(T_{PCLK} \times 256 \times 4)$  to  $(T_{PCLK} \times 2^{32} \times 4)$  in multiples of  $T_{PCLK} \times 4$ .

## 6.16 Real-time clock

The Real-Time Clock (RTC) is designed to provide a set of counters to measure time when normal or idle operating mode is selected. The RTC has been designed to use little power, making it suitable for battery powered systems where the CPU is not running continuously (Idle mode).

### 6.16.1 Features

- Measures the passage of time to maintain a calendar and clock.
- Ultra-low power design to support battery powered systems.
- Provides Seconds, Minutes, Hours, Day of Month, Month, Year, Day of Week, and Day of Year.
- Can use either the RTC dedicated 32 kHz oscillator input or clock derived from the external crystal/oscillator input at XTAL1. The programmable reference clock divider allows fine adjustment of the RTC.
- Dedicated power supply pin can be connected to a battery or the main 3.3 V.

## 6.17 System control

### 6.17.1 Crystal oscillator

The on-chip integrated oscillator operates with external crystal in range of 1 MHz to 25 MHz. The oscillator output frequency is called  $f_{osc}$  and the ARM processor clock frequency is referred to as CCLK for purposes of rate equations, etc.  $f_{osc}$  and CCLK are the same value unless the PLL is running and connected. Refer to [Section 6.17.2 "PLL"](#) and [Section 10.1 "XTAL1 input"](#) for additional information.

### 6.17.2 PLL

The PLL accepts an input clock frequency in the range of 10 MHz to 25 MHz. The input frequency is multiplied up into the range of 10 MHz to 70 MHz with a Current Controlled Oscillator (CCO). The multiplier can be an integer value from 1 to 32 (in practice, the multiplier value cannot be higher than 6 on this family of microcontrollers due to the upper frequency limit of the CPU). The CCO operates in the range of 156 MHz to 320 MHz, so there is an additional divider in the loop to keep the CCO within its frequency range while the PLL is providing the desired output frequency. The output divider may be set to divide by 2, 4, 8, or 16 to produce the output clock. Since the minimum output divider value is 2, it is insured that the PLL output has a 50 % duty cycle. The PLL is turned off and bypassed following a chip reset and may be enabled by software. The program must configure and activate the PLL, wait for the PLL to lock, and then connect to the PLL as a clock source. The PLL settling time is 100  $\mu$ s.

#### 6.17.4 Code security (Code Read Protection - CRP)

This feature of the LPC2101/02/03 allows user to enable different levels of security in the system so that access to the on-chip flash and use of the JTAG and ISP can be restricted. When needed, CRP is invoked by programming a specific pattern into a dedicated flash location. IAP commands are not affected by the CRP.

Implemented in bootloader code version 2.21 are three levels of the Code Read Protection:

1. CRP1 disables access to chip via the JTAG and allows partial flash update (excluding flash sector 0) using a limited set of the ISP commands. This mode is useful when CRP is required and flash field updates are needed but all sectors cannot be erased.
2. CRP2 disables access to chip via the JTAG and only allows full flash erase and update using a reduced set of the ISP commands.
3. Running an application with level CRP3 selected fully disables any access to chip via the JTAG pins and the ISP. This mode effectively disables ISP override using P0.14 pin, too. It is up to the user's application to provide (if needed) flash update mechanism using IAP calls or call reinvoke ISP command to enable flash update via UART0.

#### CAUTION



If level three Code Read Protection (CRP3) is selected, no future factory testing can be performed on the device.

**Remark:** Parts LPC2101/02/03 Revision 'C' have CRP2 enabled only (bootloader code version 2.2).

#### 6.17.5 External interrupt inputs

The LPC2101/02/03 include up to three edge or level sensitive external interrupt inputs as selectable pin functions. When the pins are combined, external events can be processed as three independent interrupt signals. The external interrupt inputs can optionally be used to wake-up the processor from Power-down mode and Deep power-down mode.

Additionally all 10 capture input pins can also be used as external interrupts without the option to wake the device up from Power-down mode.

#### 6.17.6 Memory mapping control

The memory mapping control alters the mapping of the interrupt vectors that appear beginning at address 0x0000 0000. Vectors may be mapped to the bottom of the on-chip flash memory, or to the on-chip static RAM. This allows code running in different memory spaces to have control of the interrupts.

#### 6.17.7 Power control

The LPC2101/02/03 supports three reduced power modes: Idle mode, Power-down mode, and Deep power-down mode.

### 6.18.1 EmbeddedICE

Standard ARM EmbeddedICE logic provides on-chip debug support. The debugging of the target system requires a host computer running the debugger software and an EmbeddedICE protocol converter. The EmbeddedICE protocol converter converts the remote debug protocol commands to the JTAG data needed to access the ARM core.

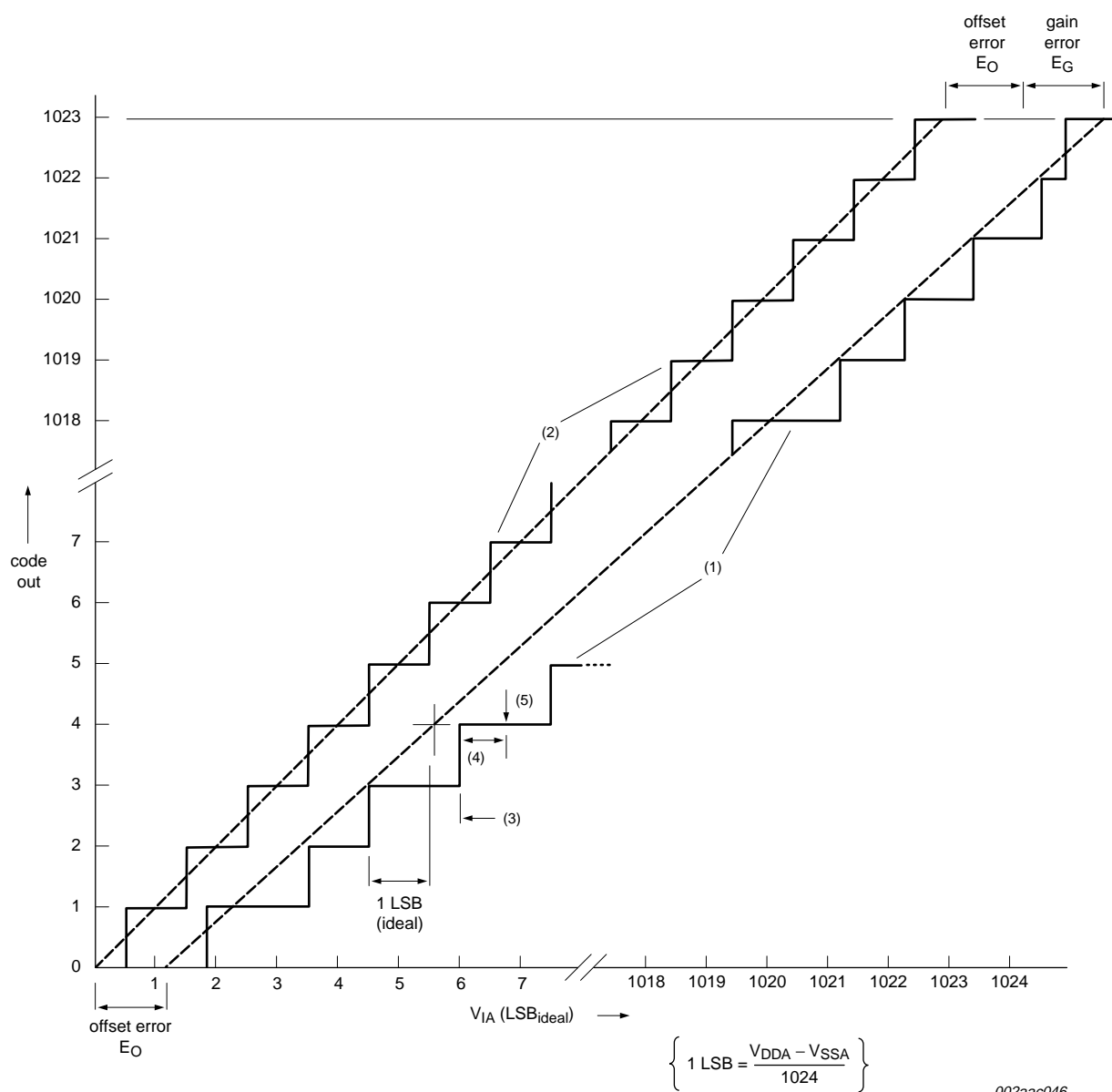
The ARM core has a debug communication channel function built-in. The debug communication channel allows a program running on the target to communicate with the host debugger or another separate host without stopping the program flow or even entering the debug state. The debug communication channel is accessed as a coprocessor 14 by the program running on the ARM7TDMI-S core. The debug communication channel allows the JTAG port to be used for sending and receiving data without affecting the normal program flow. The debug communication channel data and control registers are mapped in to addresses in the EmbeddedICE logic. The JTAG clock (TCK) must be slower than  $\frac{1}{6}$  of the CPU clock (CCLK) for the JTAG interface to operate.

### 6.18.2 RealMonitor

RealMonitor is a configurable software module, developed by ARM Inc., which enables real time debug. It is a lightweight debug monitor that runs in the background while users debug their foreground application. It communicates with the host using the DCC, which is present in the EmbeddedICE logic. The LPC2101/02/03 contain a specific configuration of RealMonitor software programmed into the on-chip boot ROM memory.

**Table 5. Static characteristics ...continued** $T_{amb} = -40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  for commercial applications, unless otherwise specified.

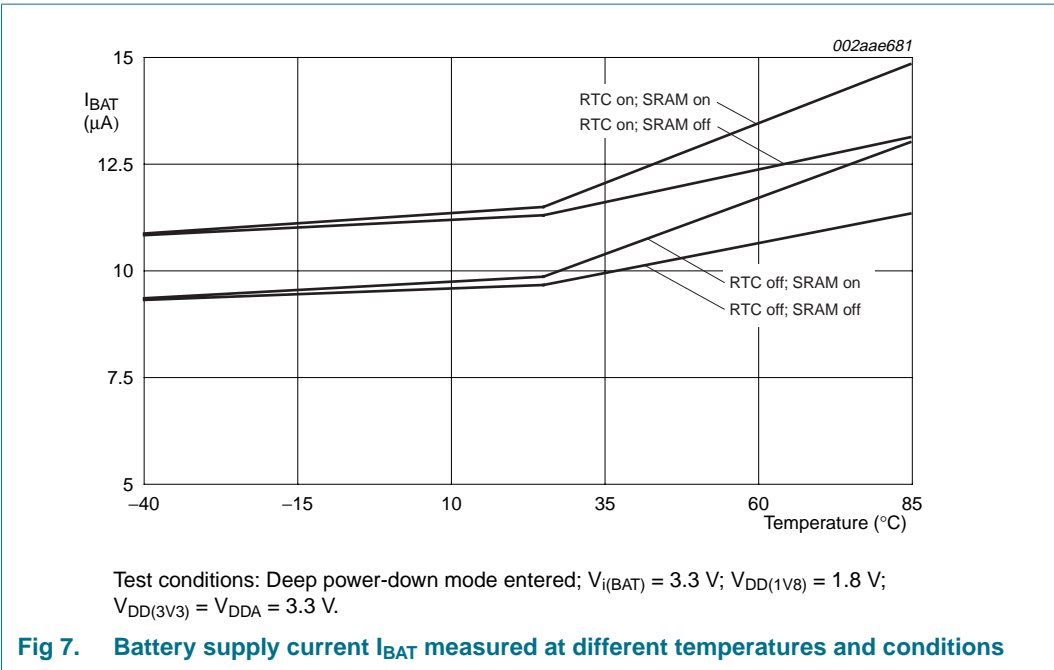
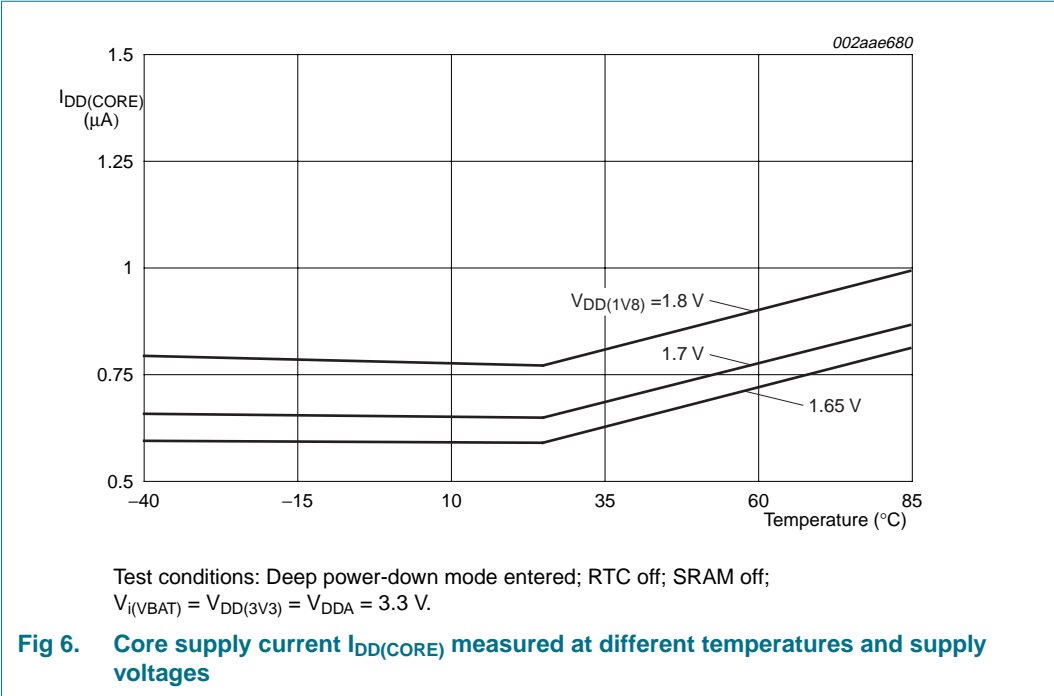
| Symbol                         | Parameter                  | Conditions                                                                                                                                                                                                                                  | Min                 | Typ <sup>[1]</sup> | Max              | Unit          |
|--------------------------------|----------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|--------------------|------------------|---------------|
| $I_{pu}$                       | pull-up current            | $V_I = 0\text{ V}$                                                                                                                                                                                                                          | <sup>[13]</sup> -15 | -50                | -85              | $\mu\text{A}$ |
|                                |                            | $V_{DD(3V3)} < V_I < 5\text{ V}$ <sup>[12]</sup>                                                                                                                                                                                            | 0                   | 0                  | 0                | $\mu\text{A}$ |
| $I_{DD(CORE)}$                 | core supply current        | <b>Active mode;</b><br>code<br><code>while(1){}</code><br>executed from flash; all peripherals enabled via PCONP register but not configured to run; CCLK = 70 MHz<br>$V_{DD(1V8)} = 1.8\text{ V}$ ; $T_{amb} = 25\text{ }^{\circ}\text{C}$ | -                   | 41                 | 70               | mA            |
|                                |                            | <b>Power-down mode;</b><br>$V_{DD(1V8)} = 1.8\text{ V}$ ; $T_{amb} = 25\text{ }^{\circ}\text{C}$                                                                                                                                            | -                   | 2.5                | 25               | $\mu\text{A}$ |
|                                |                            | $V_{DD(1V8)} = 1.8\text{ V}$ ; $T_{amb} = 85\text{ }^{\circ}\text{C}$                                                                                                                                                                       | -                   | 35                 | 105              | $\mu\text{A}$ |
|                                |                            | <b>Deep power-down mode;</b><br>RTC off; SRAM off; $T_{amb} = 25\text{ }^{\circ}\text{C}$<br>$V_{i(VBAT)} = 3.3\text{ V}$ ; $V_{DD(1V8)} = 1.8\text{ V}$                                                                                    | -                   | 0.7                | -                | $\mu\text{A}$ |
| $I_{BAT}$                      | battery supply current     | <b>Active mode;</b> CCLK = 70 MHz;<br>PCLK = 17.5 MHz;<br>PCLK enabled to RTCK;<br>RTC clock = 32 kHz (from RTCX pins); $T_{amb} = 25\text{ }^{\circ}\text{C}$                                                                              | <sup>[14]</sup>     |                    |                  |               |
|                                |                            | $V_{DD(1V8)} = 1.8\text{ V}$ ; $V_{i(VBAT)} = 3.0\text{ V}$                                                                                                                                                                                 | -                   | 10                 | 15               | $\mu\text{A}$ |
|                                |                            | <b>Power-down mode;</b><br>RTC clock = 32 kHz<br>(from RTCX pins); $T_{amb} = 25\text{ }^{\circ}\text{C}$<br>$V_{DD(1V8)} = 1.8\text{ V}$ ; $V_{i(VBAT)} = 2.5\text{ V}$                                                                    | -                   | 7                  | 12               | $\mu\text{A}$ |
|                                |                            | $V_{DD(1V8)} = 1.8\text{ V}$ ; $V_{i(VBAT)} = 3.0\text{ V}$                                                                                                                                                                                 | -                   | 8                  | 12               | $\mu\text{A}$ |
|                                |                            | <b>Deep power-down mode;</b><br>RTC off; SRAM off; $T_{amb} = 25\text{ }^{\circ}\text{C}$<br>$V_{DD(1V8)} = 1.8\text{ V}$ ; $V_{i(VBAT)} = 3.0\text{ V}$                                                                                    | -                   | 8                  | -                | $\mu\text{A}$ |
| <b>I<sup>2</sup>C-bus pins</b> |                            |                                                                                                                                                                                                                                             |                     |                    |                  |               |
| $V_{IH}$                       | HIGH-level input voltage   |                                                                                                                                                                                                                                             | $0.7V_{DD(3V3)}$    | -                  | -                | V             |
| $V_{IL}$                       | LOW-level input voltage    |                                                                                                                                                                                                                                             | -                   | -                  | $0.3V_{DD(3V3)}$ | V             |
| $V_{hys}$                      | hysteresis voltage         |                                                                                                                                                                                                                                             | -                   | $0.5V_{DD(3V3)}$   | -                | V             |
| $V_{OL}$                       | LOW-level output voltage   | $I_{OLS} = 3\text{ mA}$                                                                                                                                                                                                                     | <sup>[10]</sup> -   | -                  | 0.4              | V             |
| $I_{LI}$                       | input leakage current      | $V_I = V_{DD(3V3)}$                                                                                                                                                                                                                         | -                   | 2                  | 4                | $\mu\text{A}$ |
|                                |                            | $V_I = 5\text{ V}$                                                                                                                                                                                                                          | <sup>[15]</sup> -   | 10                 | 22               | $\mu\text{A}$ |
| <b>Oscillator pins</b>         |                            |                                                                                                                                                                                                                                             |                     |                    |                  |               |
| $V_{i(XTAL1)}$                 | input voltage on pin XTAL1 |                                                                                                                                                                                                                                             | 0                   | -                  | 1.8              | V             |



- (1) Example of an actual transfer curve.
- (2) The ideal transfer curve.
- (3) Differential linearity error ( $E_D$ ).
- (4) Integral non-linearity ( $E_{L(adj)}$ ).
- (5) Center of a step of the actual transfer curve.

**Fig 5. ADC conversion characteristics**

8.1 Power consumption in Deep power-down mode





## 9. Dynamic characteristics

**Table 7. Dynamic characteristics**

$T_{amb} = 0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$  for commercial applications,  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  for industrial applications,  $V_{DD(1V8)}$ ,  $V_{DD(3V3)}$  over specified ranges<sup>[1]</sup>.

| Symbol                                         | Parameter            | Conditions           | Min                                  | Typ <sup>[2]</sup> | Max | Unit |
|------------------------------------------------|----------------------|----------------------|--------------------------------------|--------------------|-----|------|
| <b>External clock</b>                          |                      |                      |                                      |                    |     |      |
| $f_{osc}$                                      | oscillator frequency |                      | 10                                   | -                  | 25  | MHz  |
| $T_{cy(clk)}$                                  | clock cycle time     |                      | 40                                   | -                  | 100 | ns   |
| $t_{CHCX}$                                     | clock HIGH time      |                      | $T_{cy(clk)} \times 0.4$             | -                  | -   | ns   |
| $t_{CLCX}$                                     | clock LOW time       |                      | $T_{cy(clk)} \times 0.4$             | -                  | -   | ns   |
| $t_{CLCH}$                                     | clock rise time      |                      | -                                    | -                  | 5   | ns   |
| $t_{CHCL}$                                     | clock fall time      |                      | -                                    | -                  | 5   | ns   |
| <b>Port pins (except P0.2 and P0.3)</b>        |                      |                      |                                      |                    |     |      |
| $t_{r(o)}$                                     | output rise time     |                      | -                                    | 10                 | -   | ns   |
| $t_{f(o)}$                                     | output fall time     |                      | -                                    | 10                 | -   | ns   |
| <b>I<sup>2</sup>C-bus pins (P0.2 and P0.3)</b> |                      |                      |                                      |                    |     |      |
| $t_{f(o)}$                                     | output fall time     | $V_{IH}$ to $V_{IL}$ | $20 + 0.1 \times C_b$ <sup>[3]</sup> | -                  | -   | ns   |

[1] Parameters are valid over operating temperature range unless otherwise specified.

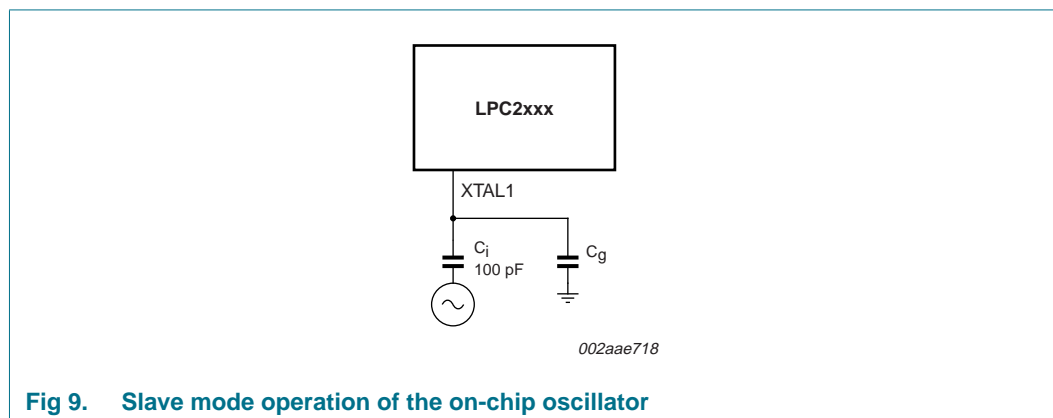
[2] Typical ratings are not guaranteed. The values listed are at room temperature ( $25^{\circ}\text{C}$ ), nominal supply voltages.

[3] Bus capacitance  $C_b$  in pF, from 10 pF to 400 pF.

## 10. Application information

### 10.1 XTAL1 input

The input voltage to the on-chip oscillators is limited to 1.8 V. If the oscillator is driven by a clock in slave mode, it is recommended that the input be coupled through a capacitor with  $C_i = 100$  pF. To limit the input voltage to the specified range, choose an additional capacitor to ground  $C_g$  which attenuates the input voltage by a factor  $C_i/(C_i + C_g)$ . In slave mode, a minimum of 200 mV (RMS) is needed. For more details see the *LPC2101/02/03 User manual UM10161*.



HVQFN48: plastic thermal enhanced very thin quad flat package; no leads;  
 48 terminals; body 7 x 7 x 0.85 mm

SOT619-7

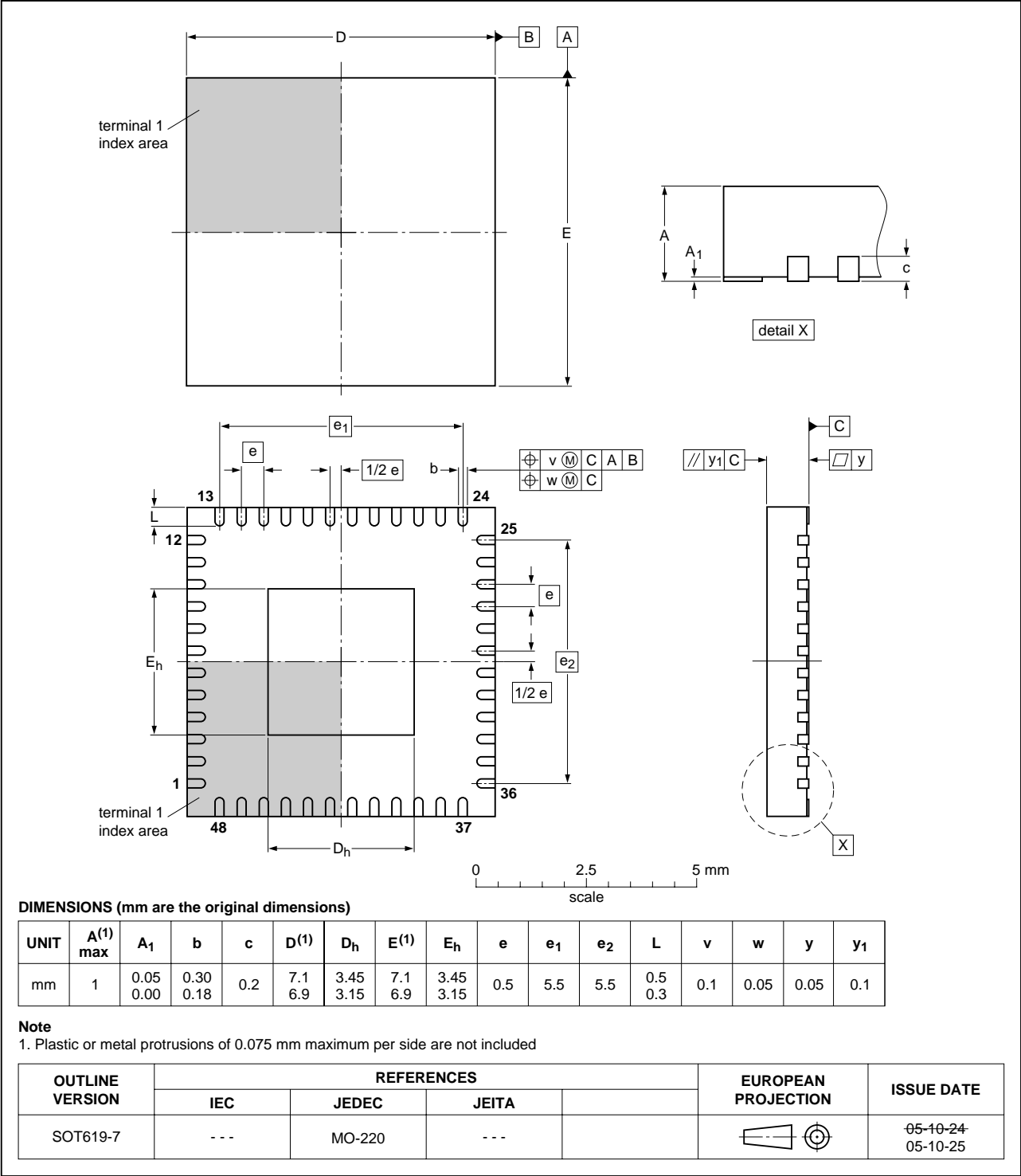


Fig 11. Package outline SOT619-7 (HVQFN48)

## 12. Abbreviations

**Table 8. Acronym list**

| Acronym | Description                                 |
|---------|---------------------------------------------|
| ADC     | Analog-to-Digital Converter                 |
| AMBA    | Advanced Microcontroller Bus Architecture   |
| APB     | Advanced Peripheral Bus                     |
| DCC     | Debug Communications Channel                |
| DSP     | Digital Signal Processor                    |
| FIFO    | First In, First Out                         |
| FIQ     | Fast Interrupt reQuest                      |
| GPIO    | General Purpose Input/Output                |
| IAP     | In-Application Programming                  |
| IRQ     | Interrupt Request                           |
| ISP     | In-System Programming                       |
| PLL     | Phase-Locked Loop                           |
| PWM     | Pulse Width Modulator                       |
| SPI     | Serial Peripheral Interface                 |
| SRAM    | Static Random Access Memory                 |
| SSI     | Synchronous Serial Interface                |
| SSP     | Synchronous Serial Port                     |
| TTL     | Transistor-Transistor Logic                 |
| UART    | Universal Asynchronous Receiver/Transmitter |
| VIC     | Vectored Interrupt Controller               |

## 13. Revision history

**Table 9. Revision history**

| Document ID     | Release date                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | Data sheet status      | Change notice | Supersedes      |
|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|---------------|-----------------|
| LPC2101_02_03_4 | 20090602                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Product data sheet     |               | LPC2101_02_03_3 |
| Modifications:  | <ul style="list-style-type: none"> <li>• <a href="#">Section 6.17.4 “Code security (Code Read Protection - CRP)”</a>: added description of three CRP levels (applicable to Revision A and higher).</li> <li>• <a href="#">Section 6.17.7 “Power control”</a>: added description of Deep power-down mode (applicable to Revision A and higher).</li> <li>• <a href="#">Section 10.1 “XTAL1 input”</a> added.</li> <li>• <a href="#">Section 10.2 “XTAL and RTC Printed Circuit Board (PCB) layout guidelines”</a> added.</li> <li>• <a href="#">Figure 6</a>, <a href="#">Figure 7</a>, <a href="#">Figure 8</a>: added power consumption data for Deep power-down mode (applicable to Revision A and higher).</li> <li>• <a href="#">Table 3</a>: added table note 7.</li> <li>• <a href="#">Table 3</a>: modified description of P0.14, RTCX1, RTCX2, XTAL1, XTAL2, JTAG, and DBGSEL pins.</li> <li>• <a href="#">Table 4</a>: modified value for <math>V_{DD(3V3)}</math>.</li> <li>• <a href="#">Table 5</a>: added and modified values for <math>V_{hys}</math>.</li> <li>• <a href="#">Table 5</a>: Voltage range for pins <math>V_{DD(3V3)}</math> and <math>V_{DDA}</math> extended to 2.6 V.</li> </ul> |                        |               |                 |
| LPC2101_02_03_3 | 20081007                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Product data sheet     | -             | LPC2101_02_03_2 |
| Modifications:  | <ul style="list-style-type: none"> <li>• Updated data sheet status to Product data sheet.</li> <li>• Table 1 and Table 2: added LPC2102FHN48 and LPC2103FHN48.</li> <li>• Table 1, Table 2, Table 3 and related figures: removed LPC2103FA44.</li> <li>• Table 3: updated pad descriptions.</li> <li>• Table 3: updated description of pin 47, SCL1.</li> <li>• Table 3: updated description of pins <math>V_{DDA}</math> and <math>V_{DD(1V8)}</math>.</li> <li>• Table 4: changed storage temperature range from <math>-40\text{ °C}/125\text{ °C}</math> to <math>-65\text{ °C}/150\text{ °C}</math>.</li> <li>• Table 5: added or modified values for <math>I_{DD(act)}</math>, <math>I_{DD(pd)}</math>, <math>I_{BATpd}</math>, <math>I_{BATact}</math>.</li> <li>• Table 5: removed “CCLK = 10 MHz” and associated values for <math>I_{DD(act)}</math>.</li> <li>• Section 5: added Figure 3.</li> <li>• Section 11: added Figure 11.</li> </ul>                                                                                                                                                                                                                                                          |                        |               |                 |
| LPC2101_02_03_2 | 20071218                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Preliminary data sheet | -             | LPC2101_02_03_1 |
| LPC2101_02_03_1 | 20060118                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Preliminary data sheet | -             | -               |

## 14. Legal information

### 14.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

### 14.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

### 14.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Terms and conditions of sale** — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

### 14.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

**I<sup>2</sup>C-bus** — logo is a trademark of NXP B.V.

## 15. Contact information

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)